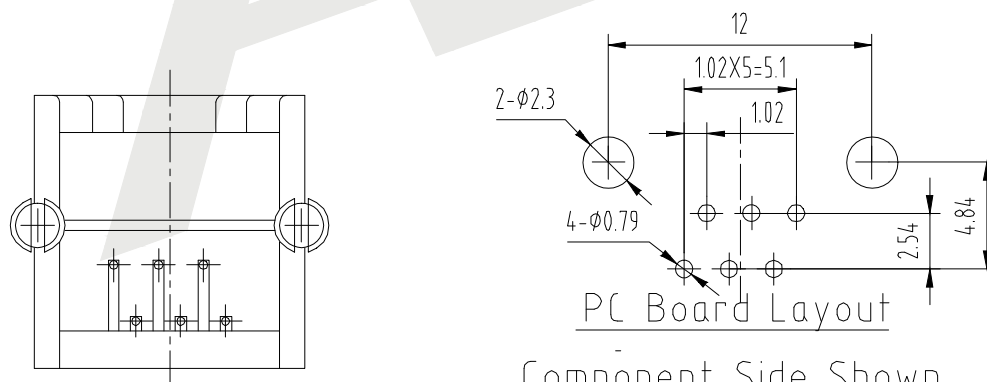
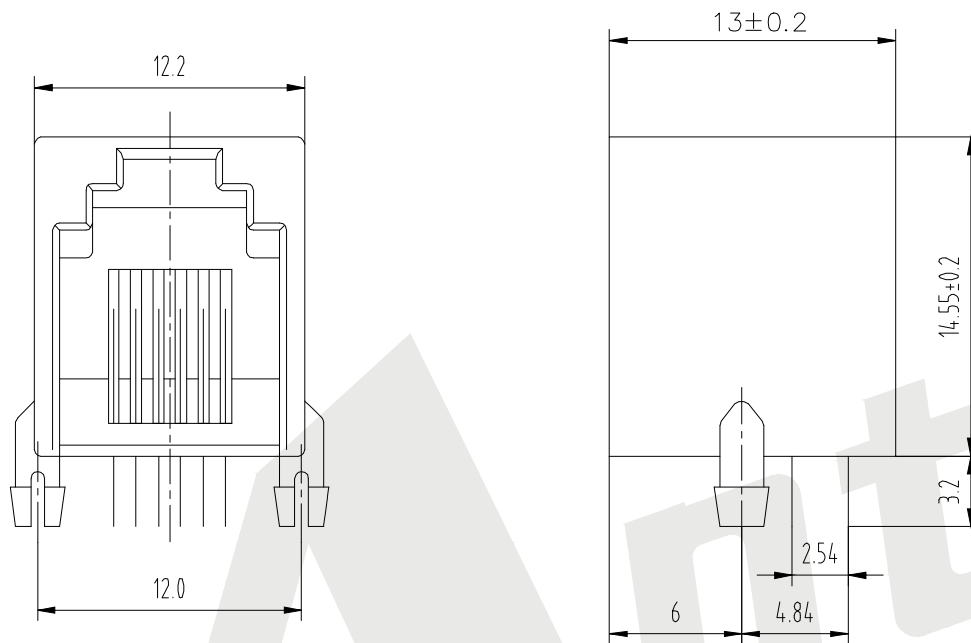


HSF



ROHS

PC Board Layout
Component Side Shown

NOTES:

MATERIAL:

1. HOUSING MATERIAL: GLASS FILLED POYESTER UL94V-0.
2. CONTACT MATERIAL: PHOSPHOR BRONZE $t=0.3\text{mm}$
3. PLATING: SELECTING GOLD PLATING $1\mu\sim 50\mu$ OVER NICKEL IN CONTACT AREA. 150μ TIN PLATIN. OVER NICKEL IN SOLDER AREA
4. SHIELD: 0.2mm THICKNESS COPPER WITH NICKEL PLATE

ELECTRICAL

1. VOLTAGE RATING: 125VAC RMS
2. CURRENT RATING: 1.5AMP
3. CONTACT RESISTANCE: 30MILLIOHMS MAX
4. INSULATION RESISTANCE 500MEGOHMS MIN @500V DC
5. DIELECTRIC WITHSTANDING RESISTANCE : 1000V AC RMS 50Hz. 1MIN

MECHANICAL

1. DURRABILITY: 750 CYCLES MIN
2. PCB RETENTION PRB-SOLDER: 1 LB MIN

REVIROMENTAL

1. STORAGE: -40°C TO 85°C
2. OPERATION: 0°C TO 70°C

Order code:

ATRJ5521 - 6P - 6C - X - A
① ② ③ ④ ⑤

① SERIES NO:

② NUMBER OF POSITIONS (8P, 6P, 4P)

③ NUMBER OF CONTACTS (8C, 6C, 4C)

④ Contact Plating

G0: Gold flash

G1: 3U" Gold

G2: 5U" Gold

G3: 10U" Gold

G4: 15U" Gold

G5: 30U" Gold

SN: Tin

⑤ Shield

A: W/O Shield

B: Half Shield

C: Shield W/Eml

D: Shield W/O Eml

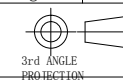
Unless Otherwise specified tolerance

X. ± 0.35 X. XX: ± 0.20
X. X: ± 0.25 X. XXX: ± 0.15

SCALE: As Shown UNIT: mm

DRAW Wu Sai DATE 06/09/2019

CHECK BobYang DATE 06/09/2019



ANTENK ELECTRONICS CO., LTD

Http://www.antenk.com

E-mail: sales@antenk.com

TITLE:

RJ11 Jack Side Entry, Full Plastic, Without Panel

DRAWING NO: ATRJ5521-6P6C-X-A-B

PRODUCT NO: ATRJ5521-6P6C-X-A-B

REV	DESCRIPTION	DATE
1		
2		
3		
4		
5		